

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	0	174/250,255,260-266.ccls and (substrate board carrier interposer) and pad same (trace conductive adj (wiring segment element)) with (taper width) and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/16 19:17
L3	63	174/250,255,260-266.ccls. and (substrate board carrier interposer) and pad same (trace conductive adj (wiring segment element)) with (taper width) and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/16 19:18
L4	151	174/250,255,260-266.ccls. and (substrate board carrier interposer) and pad and (trace conductive adj (wiring segment element)) with (taper width) and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/16 20:03
L5	124	257/734,772,773,774,776,786. ccls. and (substrate board carrier interposer) and pad and (trace conductive adj (wiring segment element)) with (taper width) and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/16 20:07
L6	128	257/734,772,773,774,776,786, E33.066,E23.01,E23.012,E23.02, E23.037,E23.04,E23.145.ccls. and (substrate board carrier interposer) and pad and (trace conductive adj (wiring segment element)) with (taper width) and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/16 20:20
L7	92	361/748,749,760,767,768,772, 774,777,807,808.ccls. and (substrate board carrier interposer) and pad and (trace conductive adj (wiring segment element)) with (taper width) and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/16 20:26